

# NEC

## GaAs MULTI-CHIP INTEGRATED CIRCUIT

### MC-5974

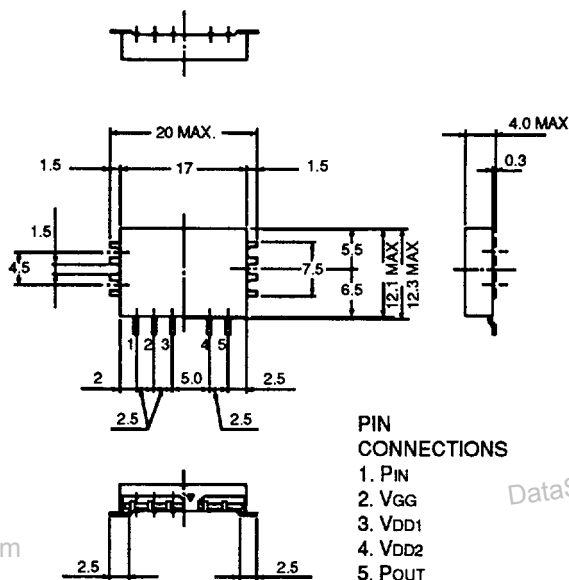
### FEATURES

- **LOW DISSIPATIVE CURRENT**  
Total Current  $I_{DD} = 410$  mA (Typ.) at  $P_{OUT} = 30.5$  dBm
- **HIGH EFFICIENCY AND LOW VOLTAGE**  
**OPERATION:** Total Efficiency,  $\eta_T = 63\%$  (Typ.) at  $P_{OUT}$  Maximum and  $V_{DD} = 4.6$  V
- **SMALL SIZE**

### DESCRIPTION

The MC-5974 is a two stage GaAs Multi-Chip Integrated Circuit (MCIC), designed to be used as the Power Amplifier in a cellular portable or handheld application. Its optimum frequency range of 872-905 MHz makes it ideal for cellular analog phones for use in Europe (E-TACS). With separate access provided to both drain supplies, the output power can be effectively controlled. With over 1 Watt output power, a low 4.6 volt supply, excellent efficiency and small size, this MCIC has advantages for a variety of portable wireless applications.

### OUTLINE DIMENSIONS (Units in mm)



- Note:
1. Lead dimensions  $0.25 \times 0.5$
  2. Tolerance of lead pitch  $\pm 0.3$

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ )

PART NUMBER PACKAGE OUTLINE			MC-5974		
SYMBOLS	PARAMETERS AND CONDITIONS <sup>1</sup>	UNITS	MIN	TYP	MAX
f	Frequency	MHz	872		905
$P_{OUT1}$	Output Power 1, $P_{IN} = 7$ dBm, $V_{DD1} = V_{DD2} = 4.6$ V, $V_{GG} = -3.5$ V	dBm	30.5	31.3	
$P_{OUT2}$	Output Power 2, $P_{IN} = 7$ dBm, $V_{DD1} = V_{DD2} = 4.0$ V, $V_{GG} = -3.5$ V	dBm		29.0	
$I_{DD}^2$	Total Current, $P_{IN} = 7$ dBm, $P_{OUT} = 30.5$ dBm, $V_{DD1} \leq 4.6$ V, $V_{DD2} = 4.6$ V, $V_{GG} = -3.5$ V	mA		410	450
2fo	Harmonics, $P_{IN} = 7$ dBm, $P_{OUT} = 30.5$ dBm, $V_{DD1} \leq 4.6$ V, $V_{DD2} = 4.6$ V, $V_{GG} = -3.5$ V	dBc			-30
3fo	Harmonics, $P_{IN} = 7$ dBm, $P_{OUT} = 30.5$ dBm, $V_{DD1} \leq 4.6$ V, $V_{DD2} = 4.6$ V, $V_{GG} = -3.5$ V	dBc			-30
4fo	Harmonics, $P_{IN} = 7$ dBm, $P_{OUT} = 30.5$ dBm, $V_{DD1} \leq 4.6$ V, $V_{DD2} = 4.6$ V, $V_{GG} = -3.5$ V	dBc			-30
$I_{GG}$	Gate Current, $P_{IN} = 7$ dBm, $P_{OUT} = 30.5$ dBm, $V_{DD1} \leq 4.6$ V, $V_{DD2} = 4.6$ V, $V_{GG} = -3.5$ V	mA		1.0	3.0
VSWR	Input VSWR, $P_{OUT} = +30.5$ dBm, $V_{DD} = 5.8$ V				3:1
	Stability Against Load Fluctuation, $P_{IN} = 7$ dBm, $P_{OUT} \geq 30.0$ dBm, $V_{GG} = -3.5$ V, $Z_S = 50 \Omega$ , ALL PHASE, Load Time = 30 s, $V_{DD1} = V_{DD2} = 8.0$ V, LOAD VSWR = 20:1		No characteristic change. Frequency, Output Power 1, 2, Total Current, Harmonics, Gate Current, Input VSWR		

Notes:

1.  $V_{GG} = \pm 0.2$  V,  $Z_S = Z_L = 50 \Omega$ .2.  $I_{DD} = I_{DD1} + I_{DD2}$

**ABSOLUTE MAXIMUM RATINGS<sup>1</sup>** ( $T_A = 25^\circ\text{C}$ )

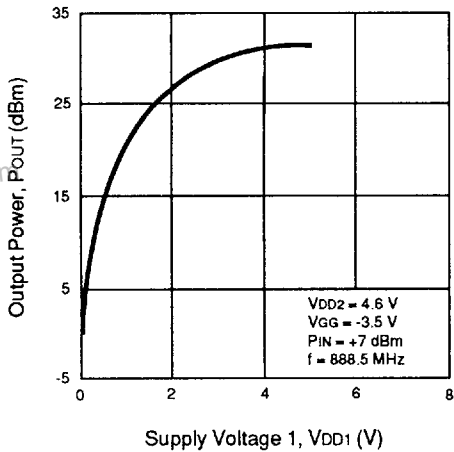
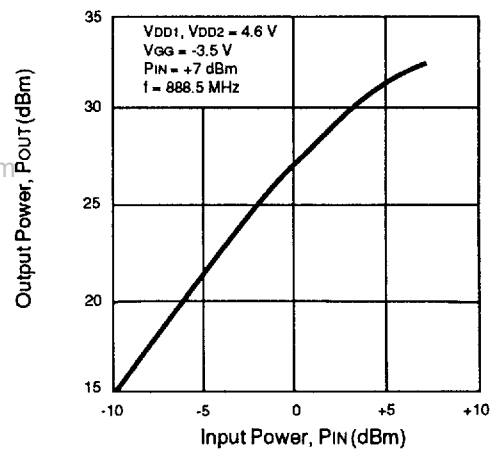
SYMBOLS	PARAMETERS	UNITS	RATINGS
VDD1, 2 <sup>2</sup>	Supply Voltage 1,2	V	10
VGG	Supply Voltage 3	V	-6
PIN	Input Power	dBm	12
Tc(OP)	Operating Case Temperature	°C	-30 to +90
TSTG	Storage Temperature	°C	-30 to +120

## Notes:

1. Operation in excess of any one of these parameters may result in permanent damage.
2. VGG = -4 V.

**RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETERS	UNITS	MIN	TYP	MAX
VDD1	Supply Voltage 1	V		4.6	4.8
VDD2	Supply Voltage 2	V	3.0	4.6	7.0
VGG	Supply Voltage 3	V	-3.3	-3.5	-3.7
PIN	Input Power	dBm		7	8

**TYPICAL PERFORMANCE CURVES** ( $T_A = 25^\circ$ )**OUTPUT POWER vs. SUPPLY VOLTAGE****OUTPUT POWER vs. INPUT POWER****OUTPUT POWER AND TOTAL CURRENT vs. FREQUENCY**